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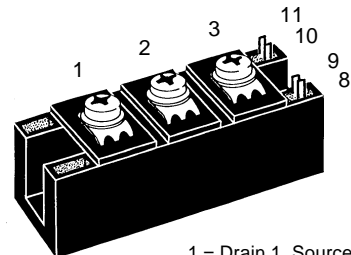
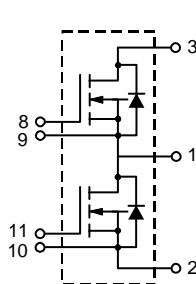


# Dual Power HiPerFET™ Module

**VMM 85-02F**

**V<sub>DSS</sub> = 200 V**  
**I<sub>D25</sub> = 84 A**  
**R<sub>DS(on)</sub> = 25 mΩ**

Phaseleg Configuration  
 High dv/dt, Low t<sub>rr</sub>, HDMOS™ Family



1 = Drain 1, Source 2  
 2 = Source 1  
 3 = Drain 2  
 8 = Gate 2  
 9 = Kelvin Source 2  
 10 = Kelvin Source 1  
 11 = Gate 1

Symbol	Conditions	Maximum Ratings	
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	200	V
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C; R <sub>GS</sub> = 10 kΩ	200	V
V <sub>GS</sub>	Continuous	±20	V
V <sub>GSM</sub>	Transient	±30	V
I <sub>D25</sub>	T <sub>C</sub> = 25°C	84	A
I <sub>D80</sub>	T <sub>C</sub> = 80°C	63	A
I <sub>DM</sub>	T <sub>C</sub> = 25°C, t <sub>p</sub> = 10 μs, pulse width limited by T <sub>JM</sub>	335	A
P <sub>tot</sub>	T <sub>C</sub> = 25°C	370	W
T <sub>J</sub>		-40 ... +150	°C
T <sub>JM</sub>		150	°C
T <sub>stg</sub>		-40 ... +125	°C
V <sub>ISOL</sub>	50/60 Hz I <sub>ISOL</sub> ≤ 1 mA	t = 1 min t = 1 s	3000 V~ 3600 V~
M <sub>d</sub>	Mounting torque (M5 or 10-32 UNF) Terminal connection torque (M5)	2.25-2.75/20-25 2.5-4/22-35	Nm/lb.in. Nm/lb.in.
Weight	Typical including screws	130	g

## Features

- Two MOSFET's in phaseleg config.
- International standard package
- Direct copper bonded Al<sub>2</sub>O<sub>3</sub> ceramic base plate
- Isolation voltage 3600 V~
- Low R<sub>DS(on)</sub> HDMOS™ process
- Low package inductance for high speed switching
- Kelvin source contact

## Applications

- Switched-mode and resonant-mode power supplies
- Uninterruptible power supplies (UPS)

## Advantages

- Easy to mount with two screws
- Space and weight savings
- High power density
- Low losses

Symbol	Conditions	Characteristic Values (T <sub>J</sub> = 25°C, unless otherwise specified)		
		min.	typ.	max.
V <sub>DSS</sub>	V <sub>GS</sub> = 0 V	200		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 8 mA	2		V
I <sub>GSS</sub>	V <sub>GS</sub> = ±20 V DC, V <sub>DS</sub> = 0			500 nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0 V, T <sub>J</sub> = 25°C V <sub>DS</sub> = 0.8 • V <sub>DSS</sub> , V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C			400 μA 2 mA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> Pulse test, t ≤ 300 μs, duty cycle d ≤ 2%		20	25 mΩ



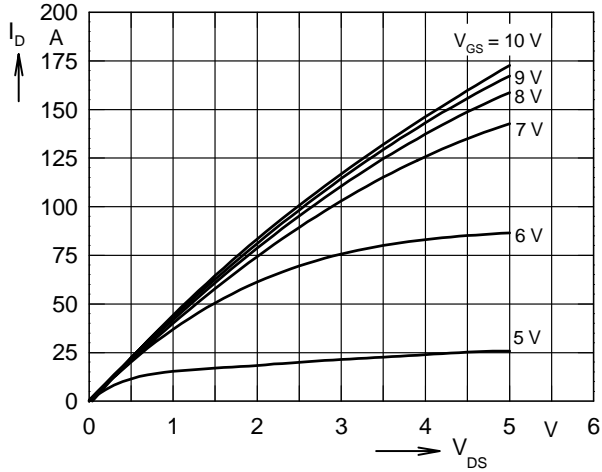


Fig. 1 Typical output characteristics  $I_D = f(V_{DS})$

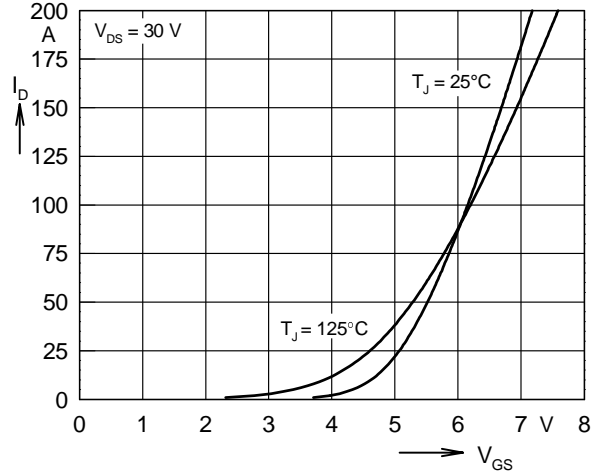


Fig. 2 Typical transfer characteristics  $I_D = f(V_{GS})$

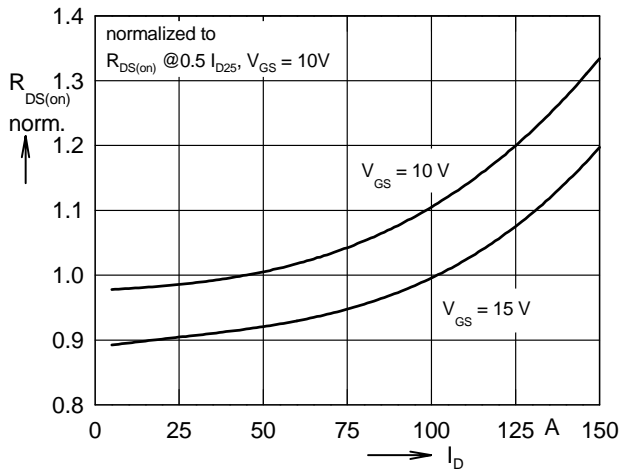


Fig. 3 Typical normalized  $R_{DS(on)} = f(I_D)$

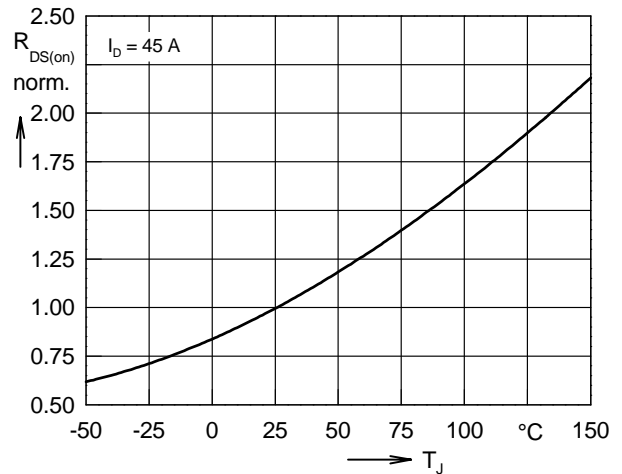


Fig. 4 Typical normalized  $R_{DS(on)} = f(T_J)$

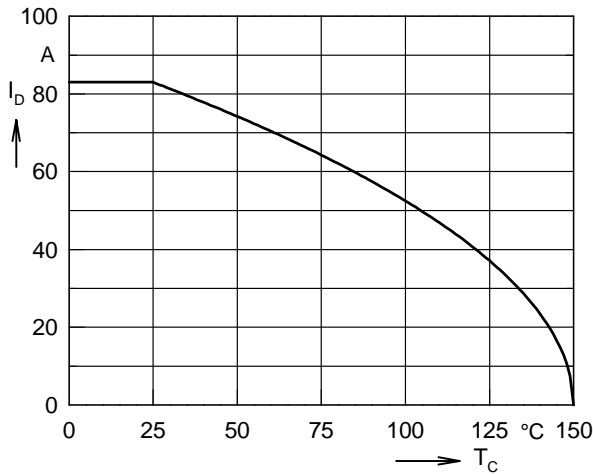


Fig. 5 Continuous drain current  $I_D = f(T_C)$

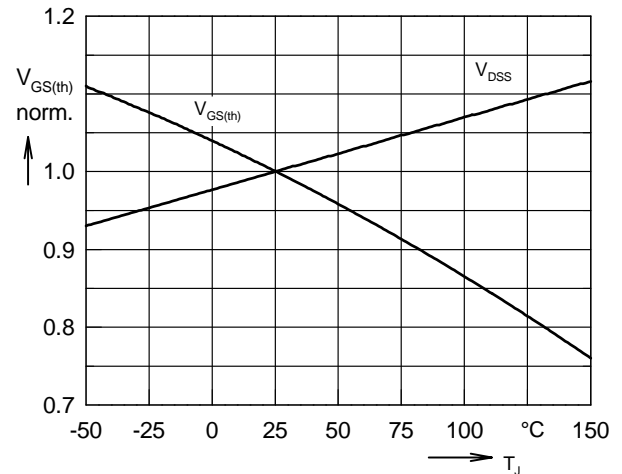


Fig. 6 Typical normalized  $V_{DS(th)} = f(T_J)$ ,  $V_{GS(th)} = f(T_J)$

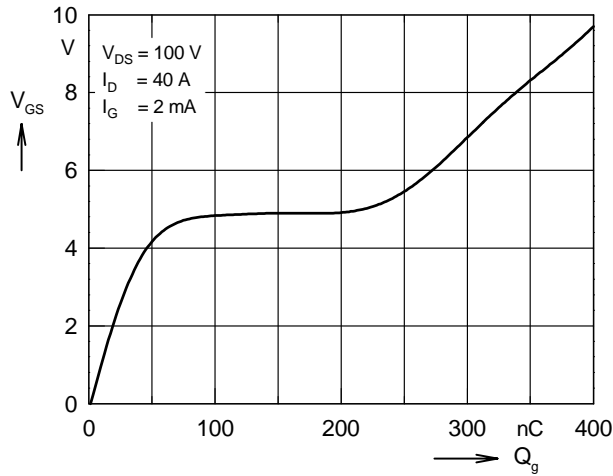


Fig. 7 Typical turn-on gate charge characteristics

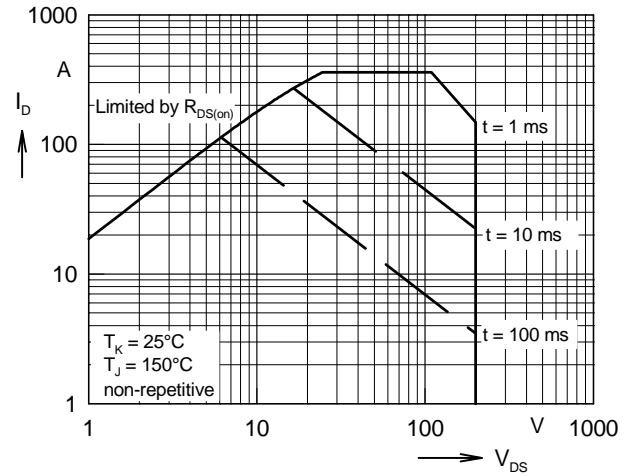


Fig. 8 Forward Safe Operating Area,  $I_D = f(V_{DS})$

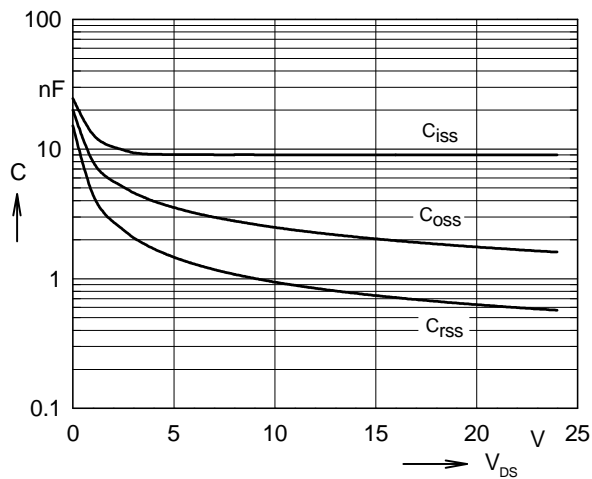


Fig. 9 Typical capacitances  $C = f(V_{DS})$ ,  $f = 1 \text{ MHz}$

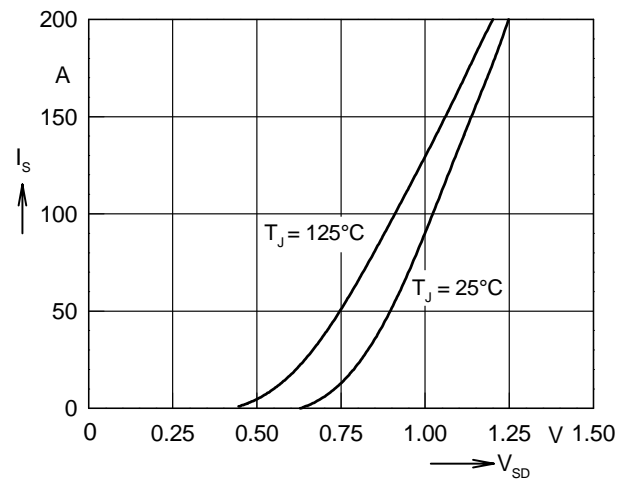


Fig. 10 Typical forward characteristics of reverse diode,  $I_S = f(V_{SD})$

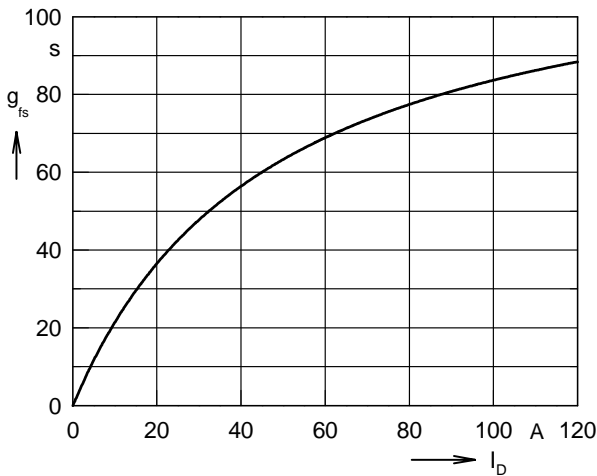


Fig. 11 Typical transconductance  $g_{fs} = f(I_D)$

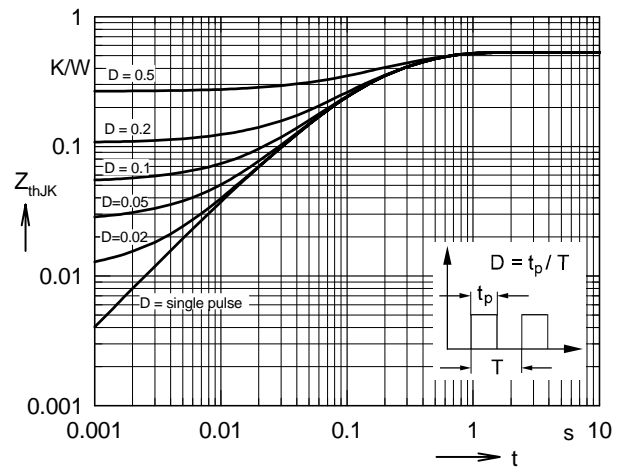


Fig. 12 Transient thermal resistance  $Z_{thJK} = f(t_p)$